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Superseding MSFC-STD-1249

**NONDESTRUCTIVE EVALUATION REQUIREMENTS FOR
FRACTURE CRITICAL METALLIC COMPONENTS**

**MEASUREMENT SYSTEM IDENTIFICATION:
INCH-POUND/METRIC**

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DOCUMENT HISTORY LOG

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FOREWORD

This Interim Technical Standard is published by the National Aeronautics and Space Administration (NASA) to provide uniform engineering and technical requirements for processes, procedures, practices, and methods to meet urgent program and project technical needs. This interim standard has the consensus of the developing Technical Working Group but does not have Agencywide concurrence required for a NASA Technical Standard.

This interim standard may be cited in contract, program, and other Agency documents as a technical requirement. Mandatory requirements are indicated by the word “shall.”

Requests for information, corrections, or additions to this standard should be submitted via “Feedback” in the NASA Technical Standards System at <http://standards.nasa.gov>.

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Approval Date

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NASA-STD-(I)-5009

TABLE OF CONTENTS

<u>SECTION</u>	<u>PAGE</u>
DOCUMENT HISTORY LOG	2
FOREWORD	3
TABLE OF CONTENTS.....	4
LIST OF FIGURES	5
LIST OF TABLES	5
1. SCOPE	6
1.1 Purpose	6
1.2 Applicability	6
2. APPLICABLE DOCUMENTS	7
2.1 General.....	7
2.2 Government Documents	7
2.3 Non-Government Documents	7
2.4 Order of Precedence	8
3. ACRONYMS AND DEFINITIONS.....	9
3.1 Acronyms.....	9
3.2 Definitions	9
4. NDE REQUIREMENTS.....	12
4.1 NDE Procedures, Standards, and Methods	12
4.2 Standard NDE.....	14
4.3 Special NDE	18
4.4 NDE Documentation	19
4.5 Personnel Qualification and Certification	21
5. GUIDANCE	26
5.1 Reference Documents	26
Appendix A Example of an NDE Organization	28

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

LIST OF FIGURES

Figure	Title	Page
1	Assumed Flaw Geometries	25

LIST OF TABLES

Table	Title	Page
1	Minimum Detectable Crack Sizes for Fracture Analysis Based on Standard NDE Methods (inches)	23
2	Minimum Detectable Crack Sizes for Fracture Analysis Based on Standard NDE Methods (millimeters)	24

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

Nondestructive Evaluation Requirements for Fracture Critical Metallic Components

1. SCOPE

1.1 Purpose

The purpose of this standard is to establish the nondestructive evaluation (NDE) requirements for fracture control of all aerospace flight systems including manned and unmanned spaceflight systems, manned and unmanned aeronautical systems, payloads, flight experiments and associated ground based hardware. This standard defines the primary requirements for NDE in support of NASA-STD-5007, General Fracture Control Requirements for Manned Spaceflight Systems. NDE applied in-process for purposes of process control is not addressed in this document.

It is the policy of NASA to produce aerospace flight systems with a high degree of reliability and safety. This is accomplished through good design; manufacturing; test and operational practices, including the judicious choice of materials, detailed analysis, appropriate factors of safety, rigorous testing and control of hardware, and reliable inspection. NASA fracture control requirements stipulate that all aerospace flight systems be subjected to fracture control procedures to preclude catastrophic failure. Those procedures frequently rely on NDE to ensure that significant crack-like flaws are not present in critical areas. NDE processes shall meet the requirements in this standard to screen hardware reliably for the presence of crack-like flaws.

Nothing in this document shall be construed as requiring duplication of effort dictated by other contract provisions. Conversely, provisions stated herein shall not be interpreted to preclude compliance with requirements invoked by other provisions.

1.2 Applicability

This standard is applicable to the fracture control of metal components, e.g. aluminum, steel, titanium, and nickel alloys for all aerospace flight systems including manned and unmanned spaceflight systems, manned and unmanned aeronautical systems, payloads, flight experiments and associated ground based hardware. Conditional notes on applicability are presented in section 4.2.3.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

The requirements described herein shall apply to fracture-critical hardware developed for NASA by NASA Centers, international partners, contractors, and outside organizations.

This standard may be cited in contract, program, and other Agency documents as a technical requirement. Mandatory requirements are indicated by the word “shall.” Tailoring of this standard for application to a specific program/project shall be approved by the Technical Authority for that program/project.

2. APPLICABLE DOCUMENTS

2.1 General

The documents listed in this section contain provisions that constitute requirements of this standard as cited in the text of section 4. The latest issuances of cited documents shall be used unless specified by version control descriptor. The applicable documents are accessible via the NASA Technical Standards System at <http://standards.nasa.gov>, directly from the Standards Developing Organizations (SDOs), or other document distributors.

2.2 Government Documents

MSFC-STD-1249	Standard NDE Guidelines and Requirements for Fracture Control Programs
NASA-STD-5007	General Fracture Control Requirements for Manned Spaceflight Systems

(Copies of the above documents are available from any NASA installation library or document repository.)

2.3 Non-Government Documents

NAS410	NAS Certification & Qualification of Nondestructive Test Personnel
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(Copies of the above document are available from the Aerospace Industries Association of America, Inc., 1250 Eye Street, N.W., Washington, DC 20005.)

ASTM-E-1417	Standard Practice for Liquid Penetrant Examination
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NASA-STD-(I)-5009

ASTM-E-1444	Standard Practice for Magnetic Particle Inspection
ASTM-E-1742	Standard Practice for Radiographic Examination
ASTM-E-2375	Standard Practice for Ultrasonic Examination of Wrought Products

(Copies of the above documents are available from the American Society for Testing and Materials, 100 Bar Harbor Drive, West Conshohocken, PA 19428.)

SAE-ARP-4402	Eddy Current Inspection of Open Fastener Holes in Aluminum Aircraft Structure
SAE-AS-4787	Eddy Current Inspection of Circular Holes in Nonferrous Metallic Aircraft Engine Hardware
SAE-AMS-2647	Fluorescent Penetrant Inspection, Aircraft and Engine Component Maintenance

(Copies of the above documents are available from SAE International, 400 Commonwealth Drive, Warrendale, PA 15096.)

2.4 Order of Precedence

In the case of conflict, the requirements in the Applicable Documents section have least precedence.

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3. ACRONYMS AND DEFINITIONS

3.1 Acronyms

ASTM	American Society for Testing and Materials
MRB	Material Review Board
NASA	National Aeronautics and Space Administration
NDE	Nondestructive Evaluation
NDI	Nondestructive Inspection
NTIAC	Nondestructive Testing Information Analysis Center
NDT	Nondestructive Testing
POD	Probability of Detection
QQI	Quantitative Quality Indicator
SAE	Society of Automotive Engineers
SDO	Standards Developing Organization

3.2 Definitions

Applicable Document: Documents cited in the body of the standard that contain provisions or other pertinent requirements directly related and necessary to the performance of the activities specified by the standard.

Approval Authority: Individuals who have the authority to change government contract requirements.

Calibration: A measurement procedure using reference standards or artifacts (for example: EDM slots or saw cuts) to assure that the NDE measurement system output is reproduced prior to initiating an NDE procedure.

Capability Demonstration Specimens: A set of specimens made from material similar to the material of the hardware to be inspected with known flaws used to estimate the capability of flaw detection, i.e., Probability of Detection (POD) or other methods of capability assessment, of an NDE system.

Cracks or Crack-Like Flaws: Flaws which are assumed to behave like cracks and may be initiated during material production, fabrication, or testing, or are developed during the service life of the part.

Critical-Initial Crack Size: The largest crack that can exist at the beginning of the service life of a structure that has an analytical life equal to the service life times the service life factor.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

Fracture Control: The rigorous application of those branches of design engineering, quality assurance, manufacturing, and operations dealing with the analysis and prevention of crack propagation leading to catastrophic failure.

Fracture Control Authority: An organization or board established by the responsible NASA Center for implementing program specific fracture control requirements.

Fracture Critical Hardware, Component, or Part: Classification that assumes that cracks in the hardware, component or part could lead to a catastrophic failure, an event that results in loss of life, serious personal injury, loss of the manned flight system or national asset.

Hardware Developer: The organization, NASA or prime contractor, responsible for the design, development, and manufacturing of hardware that is subject to fracture control.

Minimum Detectable Crack Size: The size of the smallest statistically based crack-like flaw that can be readily detected by Standard NDE methods and which is assumed to exist in a part for the purpose of performing a damage tolerance safe-life analysis of the part, component, or assembly.

NDE Plan: A plan that describes the process for establishment, implementation, and control of NDE of aerospace flight hardware during design, manufacturing and its operational life.

NDE Reliability: The reliability of an NDE procedure is the function of: (1) the Reproducibility – NDE system calibration; (2) the Capability – POD (Probability of Detection); and (3) the Repeatability – process control of the applied NDE procedure.

NDE Reference Standards: Measurement aids or flawed specimens with known artifacts used to calibrate, establish process control, or estimate the flaw detection capability of the NDE system.

Nondestructive Evaluation (NDE), Nondestructive Inspection (NDI), Nondestructive Testing (NDT): Inspection techniques which do not cause physical, mechanical, or chemical changes to the part being inspected or otherwise impair its adequacy for operational service. These inspection techniques are applied to materials and structures to verify required integrity and to detect flaws.

Probability of Detection (POD): The mean fraction of flaws at a given size expected to be detected.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

Reference Document: A document that is useful as background information for the reader to help in understanding the subject matter but does not constitute technical requirements of the standard.

Responsible NASA Center: The NASA center where an organization or program office institutes a fracture control program.

Responsible NDE Engineering: The NDE engineering organization of the hardware developer or the sustaining engineering organization responsible for the engineering aspect of fracture-critical NDE during manufacturing or operations and maintenance.

Special NDE: Nondestructive inspections of fracture critical hardware that are capable of detecting cracks or crack-like flaws smaller than those assumed detectable by Standard NDE or do not conform to the requirements for Standard NDE as set forth in this document. Special NDE methods are not limited to fluorescent penetrant, radiography, ultrasonic, eddy current, and magnetic particle.

Standard NDE: NDI methods of metallic materials for which a statistically based flaw detection capability has been established. Standard NDE methods addressed by this document are limited to fluorescent penetrant, radiography, ultrasonic, eddy current, and magnetic particle.

Sustaining Engineering: The organization, NASA or prime contractor, responsible for operation and maintenance of hardware that is subject to fracture control.

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4. NDE REQUIREMENTS

The requirements set forth in this standard are the minimum NDE requirements for fracture-critical hardware. The application of Standard and Special NDE per the requirements of this Standard does not exempt fracture-critical hardware from routine NDE performed during manufacturing. The fracture control NDE procedures cited herein may exceed the requirements for NDE procedures that are routinely performed for purposes such as configuration control and process control. NASA-STD-5007 provides the definition of fracture-critical hardware for all spaceflight systems. NASA-STD-5007 requires that all fracture-critical parts shall be subjected to NDE and/or proof testing to screen for internal and external cracks.

4.1 NDE Procedures, Standards, and Methods

NDE procedures, standards, methods and acceptance criteria shall be defined, validated, documented, approved, implemented and updated during all phases of life-cycle such as manufacturing, operation, and maintenance of each fracture-critical part.

- a. All NDE inspections shall be conducted by certified NDE inspectors.
- b. The fracture-critical NDE inspection procedure shall be clearly defined for each type of part.
- c. Effective and reliable NDE methods shall be selected for all part life cycles, including but not limited to manufacturing, maintenance and operations.
- d. All identified part areas shall be inspectable.

4.1.1 Cracks

All detected cracks or crack-like flaws, regardless of size, shall be cause for rejection.

4.1.2 Material Review Board (MRB)

The acceptance of cracks of any size in a fracture critical part shall require a MRB action and the approval of the responsible fracture control authority.

4.1.3 Detailed NDE Requirements

The NDE methods applied shall comply with the Standard NDE requirements of paragraph 4.2.1 or the Special NDE requirements of paragraph 4.2.3.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

4.1.4 NDE Drawing Callouts

NDE inspection requirements for all fracture-critical parts shall be clearly identified in all drawings.

- a. The drawings shall clearly identify each inspection requirement by zone when different zones require different NDE inspection requirements and acceptance criteria.
- b. All drawings shall be updated when NDE inspection requirements are updated.

4.1.5 NDE Process and Configuration Control

A written procedure for each fracture-critical part shall be developed that complies with the relevant specification for the NDE method selected.

- a. Configuration control by revision or date shall be maintained current for the following:
 - (1) Personnel Qualification
 - (2) Personnel Certification
 - (3) NDE Specification
 - (4) NDE Standards
 - (5) NDE Part Specific Procedures
- b. All process changes that affect the reliability of a fracture-critical part must be approved by the appropriate technical authority.

4.1.6 Capability Demonstration Specimens

- a. NDE capability demonstration specimens shall be used for determining the detection capability for all Special NDE applications and may be used to validate the capabilities of Standard NDE procedures.
- b. Specimens shall be representative of the critical inspection area for the applicable hardware, and shall be representative of or transferable to the flaw size, type, location, and orientation.
- c. Specimens shall be borrowed from NASA or other Government departments when available.
- d. If appropriate demonstration specimens are not available, specimens shall be built or procured that meet both specimen requirements and fracture control requirements.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

e. Specimens used shall be documented as a part of the NDE procedures and personnel skill qualifications.

4.1.7 Supporting Data and Record Retention

All certification records, NDE reports and associated paperwork shall be retained through the life of the program.

4.1.8 Organizational Guidelines and Documentation Requirement

It is recommended that a document be developed that meets the responsibility and authority intent provided in Appendix A.

4.2 Standard NDE

Standard NDE shall consist of formal NDIs of fracture critical hardware using the NDE methods cited in table 1. The minimum detectable crack sizes shown in table 1 are assumed in the damage tolerance fracture analyses and are applicable only for metals. The crack geometries for the cracks in table 1 are shown in figure 1.

4.2.1 Standard NDE Methods

Standard NDE methods shall be limited to eddy current, fluorescent penetrant, magnetic particle, radiography, and ultrasonics.

4.2.2 Standard NDE Crack Sizes

NDIs of fracture critical hardware shall detect the initial crack sizes used in the damage tolerance fracture analyses with a capability of 90/95 (90 percent probability of detection at a 95 percent confidence level). The minimum detectable crack sizes for the Standard NDE methods shown in table 1 meet the 90/95 capability requirement. The crack size data in table 1 are based principally on an NDE capability study that was conducted on flat, fatigue cracked 2219-T87 aluminum panels early in the Space Shuttle program. Although many other similar capability studies and tests have been conducted since, none have universal application, neither individually nor in combination. Conducting an ideal NDE capability demonstration where all of the variables are tested is obviously unmanageable and impractical.

4.2.2.1 In order to make the broadest use of the NDE reliability data in table 1, the terms “representative” and “reasonable” must be applied in the application of such data to real inspections.

4.2.2.2 Regardless of the level of capability required of an inspection, the application of NDE generally requires that the surfaces inspected be clean, smooth, and accessible.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

When the component's geometrical features, such as sharp radii, fillets, recesses, surface finish and cleanliness, material selection and other conditions can influence the capability of the applied Standard NDE method, the method shall be evaluated to ensure that the detection capability of the applied Standard NDE inspection is not influenced – see section 4.2.3. The conditions and their evaluation shall be documented in the NDE Summary Report.

4.2.3 Table 1—Minimum Detectable Flaw Sizes Conditional Notes

Since the table 1 crack sizes were derived from a limited set of specimens of simple geometry, applying the crack sizes to complex geometries; other materials, material forms, material processes, and non standard NDE applications must be done with caution.

4.2.3.1 Where the real inspection conditions deviate significantly from the concept of flat fatigue-cracked panel inspections, the transferability or similarity of the application of the table 1 crack sizes to real inspection situations must be evaluated and verified by documented evidence. Similarity can be established by other studies or data or by supportable rationale. Similarity considerations should meet the intent of MIL-HDBK-1823, Nondestructive Evaluation System, Reliability Assessment.

4.2.3.2 If similarity cannot be established, additional tests may be required including Standard or Special NDE demonstration tests. The values listed in tables 1 and 2 may not apply to thick-section components; threaded parts; weldments; compressively loaded structures; double wall radiography; and other unique material, structural, or inspection applications.

4.2.4 Demonstration of Standard NDE Capability

NDE procedure calibration on simulated or real crack-like flaws shall demonstrate detection of the minimum detectable crack size.

4.2.4.1 Implementation of Standard NDE methods in accordance with the following requirements shall not require a formal demonstration of crack detection capability.

4.2.5 Standard NDE Inspection Process Requirements

If the requirements of this paragraph cannot be met or smaller cracks or crack like flaws than those shown in table 1 must be detected, then the inspection processes shall be considered Special NDE, and the Special NDE requirements of paragraph 4.3 shall apply.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

4.2.5.1 Eddy Current

Eddy-current inspections shall be in accordance with

SAE-ARP-4402, Eddy Current Inspection of Open Fastener Holes in Aluminum Aircraft Structure; SAE-AS-4787, Eddy Current Inspection of Circular Holes in Nonferrous Metallic Aircraft Engine Hardware; or NASA-approved contractor internal specifications. Eddy-current inspection can only be applied to nonmagnetic, nonferromagnetic and conductive metals.

4.2.5.1.1 The influence of coatings and lift-off variations on the reliability of an eddy-current Standard NDE inspection process shall be evaluated and taken into account in the application.

4.2.5.2 Fluorescent Penetrant

Fluorescent Penetrant inspection shall be in accordance with ASTM-E-1417, Standard Practice for Liquid Penetrant Examination (superseded by Standard Practice for Liquid Penetrant Testing); SAE-AMS-2647, Fluorescent Penetrant Inspection, Aircraft and Engine Component Maintenance; or NASA-approved contractor internal specifications.

4.2.5.2.1 The penetrant system used shall be a fluorescent penetrant of Level 4 sensitivity.

4.2.5.2.2 Mechanically Disturbed Surfaces

Mechanically disturbed surfaces shall be etched prior to the penetrant inspection and at an appropriate time in the manufacturing flow. The final penetrant inspection can be performed prior to metal finishing operations such as buffing or sanding that do not by themselves produce flaws.

4.2.5.2.2.1 Etching Procedure

An etching procedure shall be developed, approved, and controlled to prevent part damage. The etching procedure shall specify the minimum amount of material to be removed to ensure that smeared metal does not mask cracks.

4.2.5.2.2.2 The etching process shall not exceed engineering drawing tolerances for part dimensions and finishes. When very close tolerances are required, critical surfaces should be machined near final dimensions, etched and inspected, and finish machined.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

4.2.5.3 Magnetic Particle

Magnetic Particle inspections shall be in accordance with ASTM-E1444, Standard Practice for Magnetic Particle Inspection; or NASA-approved contractor internal specifications.

4.2.5.3.1 The Magnetic Particle inspection shall be the wet, fluorescent, continuous, or multi-mag method.

4.2.5.3.2 A Quantitative Quality Indicator (QQI) shall be used to validate the local field intensities. Hall probes are acceptable provided they are verified with a QQI. Pie gages are not acceptable for measuring field intensities.

4.2.5.4 Radiography

Radiographic inspections shall be in accordance with ASTM-E-1742, Standard Practice for Radiographic Examination; or with NASA-approved contractor internal specifications.

4.2.5.4.1 The minimum radiographic inspection sensitivity level shall be 2-1T.

4.2.5.4.2 Film density shall be 2.5 to 4.0.

4.2.5.4.3 The plane of radiation shall be within +/-5 degrees of the assumed crack orientation.

4.2.5.5 Ultrasonics

Ultrasonic inspections for wrought products shall be in accordance with ASTM-E-2375, Standard Practice for Ultrasonic Examination of Wrought Products; and with NASA-approved contractor internal specifications.

4.2.6 Standard NDE Classification Justification

The justification to classify an NDE procedure as a Standard NDE procedure shall be documented and approved. The justification shall be based upon evaluation of the NDE procedure as applied to the hardware. Justification shall include evaluating the similarity of the NDE procedure on the hardware with other NDE procedures on similar or identical hardware that have documented flaw detectability equal to or better than the Standard NDE minimum detectable crack size from table 1.

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NASA-STD-(I)-5009

4.2.7 Standard NDE Deviations

All Standard NDE deviations shall be approved by the NDE engineering authority and the appropriate fracture control authority.

4.3 Special NDE

4.3.1 General

Special NDE consists of NDIs that must be capable of detecting crack-like flaws smaller than those detectable by Standard NDE or those that do not conform to the requirements for Standard NDE given in section 4.2, Standard NDE. Special NDE methods are not limited to fluorescent penetrant, radiography, ultrasonic, eddy current, and magnetic particle methods.

4.3.2 Special NDE Crack Sizes

The Special NDE crack size can be any demonstrated size; however, Special NDE inspections shall require the approval of the responsible fracture control authority. In those cases where the damage tolerance analysis requires smaller flaw sizes than those given in table 1 for Standard NDE or the Standard NDE methods given in table 1 are not applicable, then a Special NDE inspection is required.

4.3.3 Demonstration of Special NDE Capability

A 90/95 percent flaw detection capability shall be demonstrated before a Special NDE inspection can be implemented. The demonstration of the Special NDE inspection at a given crack size qualifies the Special NDE for implementation for the detection of cracks at the demonstrated size and larger.

a. The flaw detection capability of the Special NDE inspection method must be demonstrated by test with flawed specimens.

b. A sufficient number of flaws must be included in the test demonstration to meet the 90/95 percent reliability requirement.

c. The tests shall be designed on the basis of either the Point Estimate Method (paragraph 4.3.5), the Probability of Detection Method (paragraph 4.3.6), or other approved method

4.3.4 NDE Capability Demonstration Specimens

The most accepted method of demonstrating Special NDE capability is with fatigue-cracked specimens. The preparation and control of demonstration specimens and how to

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NASA-STD-(I)-5009

administer a demonstration tests should meet the intent of MIL-HDBK-1823. In special cases, other flaws or crack types that are more representative of the application may be used for the demonstration with the approval of the responsible fracture control authority.

Special NDE demonstration specimen selection shall be justified and approved based on the similarity between the test hardware and the demonstration specimen. The justification shall be documented in the NDE summary report.

4.3.5 Point Estimate Method

The Point Estimate Method approach assumes that the capability of flaw detection increases with the size of flaws in the neighborhood of the test flaw size. Since only a small number of flaws are required by this method, the minimum detectable flaw size may not be a determinant. The above assumption shall be demonstrated or verified by documented evidence before the Point Estimate Method can be implemented. Qualification by this method demonstrates that the procedure and the individual operator are capable of detecting flaws of the test size and larger. Use of the Point Estimate Method should be in accordance with the recommended practice found in *Materials Evaluation*, Vol. 40, No. 9, 1982 (see section 5.1, Reference Documents).

4.3.6 POD Method

This method requires a large range of flaw sizes that span the expected critical initial flaw size. The large number of flaws required by this method usually allows a minimum detectable flaw size to be determined. Qualification by this method demonstrates that the procedure, either manual or automated, and the individual operator are capable of detecting the minimum detectable flaw size and larger. Use of the POD method should meet the intent of MIL-HDBK-1823.

4.4 NDE Documentation

4.4.1 NDE Plan

An overall NDE plan shall be developed which shall address NDE requirements, as a minimum:

- a. Applicable specifications and standards
- b. Calibration artifact traceability
- c. Inspector training, qualification, and certification
- d. Method selection, application, and process control

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

- e. Acceptance criteria
- f. Application of requirements during manufacturing, maintenance and operations.
- g. NDE applied to fracture critical hardware
- h. Standard NDE selection, application, and control
- i. Special NDE selection, application, and control

4.4.2 NDE Summary Report

A NDE Summary Report shall be developed which shall include, but not be limited to, the following:

- a. Identification of the fracture critical part number
- b. Critical zones inspected
- c. NDE methods applied and procedures used
- d. Classification and justification of Standard NDE or Special NDE inspections
- e. Acceptance criteria
- f. Inspector's names and inspection dates
- g. Evaluation of special conditions that effect Standard NDE

4.4.2.1 The report shall provide inspection results including flaw descriptions, locations and sizes and other non-conformances and problems encountered.

4.4.2.2 The report shall identify any cracks or crack-like flaws regardless of their size or disposition.

4.4.3 Supporting Data and Record Retention

The documents supporting the NDE Summary Report shall be kept for the life of the program. These documents shall include, but are not limited to, the following:

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NASA-STD-(I)-5009

- a. Controlling NDE specifications and standards
- b. Part-specific NDE procedures
- c. Special NDE 90/95 percent capability demonstration data
- d. Supporting data used to justify Standard NDE
- e. Standard and Special NDE inspector qualification and certification documents
- f. Standard and Special NDE process changes and approval documents
- g. The hardware acceptance, inspection and summary reports.
- h. Other supporting data includes inspector identifications, inspection dates, detailed and zoned drawings, acceptance criteria, and NDE problem reports and resolutions
- i. NDE reports

4.4.3.1 These documents shall be available for audit by the responsible fracture control authority and others.

4.5 Personnel Qualification and Certification

4.5.1 Standard NDE Qualification and Certification

Personnel performing standard NDIs of fracture critical hardware shall be, at a minimum, certified Level II in accordance with NAS 410, NAS Certification & Qualification of Nondestructive Test Personnel.

4.5.2 Special NDE Qualification and Certification

Personnel performing Special NDE shall be qualified and certified for each Special NDE procedure. Successful demonstration of 90/95 percent capability on the NDE reliability demonstration specimens qualifies the specific written procedure and inspector performing the inspection for detecting the demonstrated flaw size and larger. If there is a failure to demonstrate capability, then proof of improved inspector skills shall be required prior to a retest.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

- a. Qualification for Special NDE shall be specific to the procedure and the inspector.
- b. Special NDE inspection shall not be transferable to another procedure or inspector.
- c. The period of Special NDE certification shall be 3 years. Demonstration of skills is required during the certification process.

This document represents the technical consensus of the developing group but does not yet have final NASA approval.

NASA-STD-(I)-5009

Table 1—Minimum Detectable Crack Sizes for Fracture Analysis Based on Standard NDE Methods (See Condition Notes, Section 4.2.3 for applicability.)

U. S. CUSTOMARY UNITS (inches)

Crack Location	Part Thickness, t	Crack Type	Crack Dimension, a*	Crack Dimension, c*
<u>Eddy Current NDE</u>				
Open Surface	$t \leq 0.050$	Through PTC ¹	t	0.050
	$t > 0.050$		0.020 0.050	0.100 0.050
Edge or Hole	$t \leq 0.075$	Through Corner	t	0.100
	$t > 0.075$		0.075	0.075
<u>Penetrant NDE</u>				
Open Surface	$t \leq 0.050$	Through PTC	t	0.100
	$0.050 < t < 0.075$		t	0.150 - t
	$t > 0.075$		0.025 0.075	0.125 0.075
Edge or Hole	$t \leq 0.100$	Through Corner	t	0.150
	$t > 0.100$		0.100	0.150
<u>Magnetic Particle NDE</u>				
Open Surface	$t \leq 0.075$	Through PTC	t	0.125
	$t > 0.075$		0.038 0.075	0.188 0.125
Edge or Hole	$t \leq 0.075$	Through Corner	t	0.250
	$t > 0.075$		0.075	0.250
<u>Radiographic NDE</u>				
Open Surface	$t \leq 0.107$	PTC PTC Embedded	0.7t	0.075
	$t > 0.107$		0.7t 2a=0.7t	0.7t 0.7t
<u>Ultrasonic NDE</u> Comparable to a Class A Quality Level (ASTM E 2375)				
Open Surface	$t \geq 0.100$	PTC	0.030	0.150
			0.065	0.065
		Embedded**	0.17	0.087
			0.039	0.039

¹ PTC - Partly through crack (Surface Crack)

* See figure 1 for definitions of “a” and “c” for different geometries.

** Equivalent area is acceptable. ASTM-E-2375 Class A.

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NASA-STD-(I)-5009

**Table 2—Minimum Detectable Crack Sizes for Fracture Analysis
Based on Standard NDE Methods (Metric Version)
See Condition Notes, Section 4.2.3 for applicability**

Système International (SI) Units (millimeters)

Crack Location	Part Thickness, t	Crack Type	Crack Dimension, a*	Crack Dimension, c*
<u>Eddy Current NDE</u>				
Open Surface	$t \leq 1.27$	Through PTC ¹	t	1.27
	$t > 1.27$		0.51	2.54
			1.27	1.27
Edge or Hole	$t \leq 1.91$	Through Corner	t	2.54
	$t > 1.91$		1.91	1.91
<u>Penetrant NDE</u>				
Open Surface	$t \leq 1.27$	Through Through PTC	t	2.54
	$1.27 < t < 1.91$		t	3.81 – t
	$t > 1.91$		0.64	3.18
			1.91	1.91
Edge or Hole	$t \leq 2.54$	Through Corner	t	2.54
	$t > 2.54$		2.54	2.54
<u>Magnetic Particle NDE</u>				
Open Surface	$t \leq 1.91$	Through PTC	t	3.18
	$t > 1.91$		0.97	4.78
			1.91	3.18
Edge or Hole	$t \leq 1.91$	Through Corner	t	6.35
	$t > 1.91$		1.91	6.35
<u>Radiographic NDE</u>				
Open Surface	$t \leq 2.72$	PTC PTC Embedded	0.7t	1.91
	$t > 2.72$		0.7t	0.7t
			2a=0.7t	0.7t
<u>Ultrasonic NDE</u> Comparable to a Class A Quality Level (ASTM E 2375)				
Open Surface	$t \geq 2.54$	PTC	0.76	3.81
			1.65	1.65
		Embedded**	0.43	2.21
			0.99	0.99

¹ PTC – Partly through crack (Surface Crack)

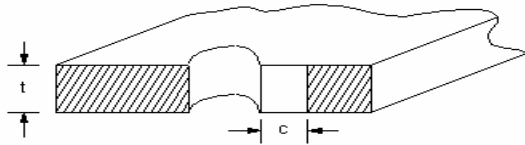
* See figure 1 for definitions of “a” and “c” for different geometries.

** Equivalent area is acceptable, ASTM-E-2375 Class A.

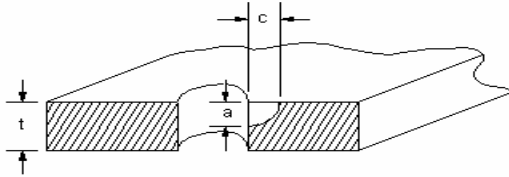
This document represents the technical consensus of the developing group but does not yet have final NASA approval.

GEOMETRIES FOR CRACKS AT HOLES

THROUGH CRACK

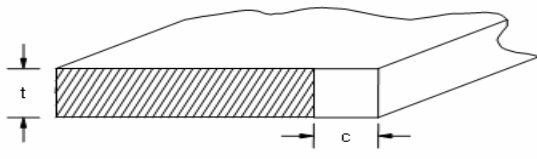
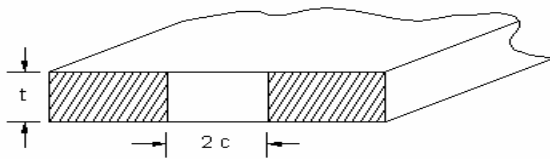


CORNER CRACK



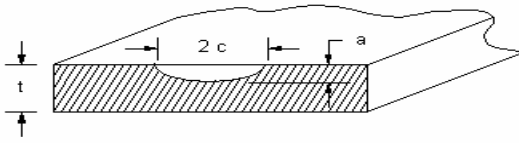
GEOMETRIES FOR CRACKS NOT AT HOLES

THROUGH CRACKS

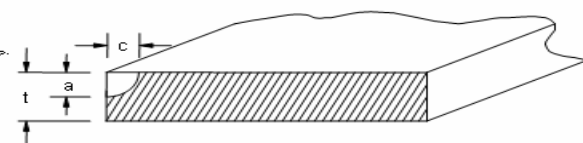


PARTIALLY THROUGH CRACKS

SURFACE CRACK



CORNER CRACK



EMBEDDED CRACK

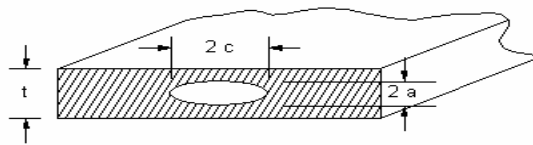


Figure 1—Assumed Flaw Geometries

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NASA-STD-(I)-5009

5. GUIDANCE

5.1 Reference Documents

5.1.1 Government Documents

MIL-HDBK-1823	Nondestructive Evaluation System Reliability Assessment
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(Copies of the above document are available from Standardization Documents Order Desk, Bldg. 4 Section D, 700 Robbins Ave., Philadelphia, PA 19111-5094, Attn: NPODS.)

NASA-STD-5003	Fracture Control Requirements for Payloads Using the Space Shuttle
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SSP 30558	Fracture Control Requirements for Space Station
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SSP 52005	Payload Flight Equipment Requirements and Guidelines for Safety-Critical Structures
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NSTS 1700.7B	ISS Addendum, Safety Policy and Requirements for Payloads Using the International Space Station, Change No. 3, February 1, 2002
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(Copies of the above documents are available from any NASA Installation library or document repository.)

5.1.2 Non-Government Documents

NTIAC-DB-97-02	Nondestructive Evaluation (NDE) Capabilities Data Book
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NTIAC-TA-00-01	Probability of Detection (POD) for Nondestructive Evaluation (NDE)
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(Copies of the above documents are available from Advanced Materials, Manufacturing, and Testing Information Analysis Center, 201 Mill Street, Rome, NY 13440, Phone (315) 339-7117, Fax (315) 339-710

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NASA-STD-(I)-5009

Materials Evaluation,
Volume 40, No. 9 , 1982

“Recommended Practice for a Demonstration of
Nondestructive Evaluation (NDE) Reliability
On Aircraft Production Parts,” Ward Rummel.

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developing group but does not yet have final NASA approval.*

**APPENDIX A
EXAMPLE OF AN NDE ORGANIZATION**

The following is an example of an NDE Organization with clearly defined roles, responsibilities, and implementation.

A.1 Implementation and Responsibilities

A.1.1 Oversight Responsibility

The responsible NASA center shall provide an NDE oversight function and approval of the hardware developer's NDE Plan and program for the inspection of fracture critical hardware. The NASA oversight function shall establish periodic reviews of the hardware developer's NDE program. The NDE oversight function shall be responsible for establishing the personnel certification system for Special NDE procedures when NASA conducts the certification tests. NDE standards and procedures for fracture critical hardware shall be approved by the responsible NASA center. In general, all plans, data, documentation, reference standards, and reliability demonstration specimens generated under contract from NASA to its contractors, subcontractors and suppliers in fulfillment of these requirements during hardware development, manufacturing, operations and maintenance shall be subject to examination, evaluation, and inspection by and delivery to the NDE oversight function or designated representatives of the responsible NASA center.

A.1.2 Responsibility of Hardware Specific NDE Requirements

The hardware developer, in concurrence with the fracture control authority shall establish and provide hardware specific NDE requirements to its in-house NDE inspection organizations, suppliers, subcontractors, and vendors to accomplish the NDE during manufacturing. The hardware developer, in concurrence with the fracture control authority shall provide the hardware-specific NDE requirements for operations and maintenance to the responsible NASA center or its designated sustaining engineering organization. The sustaining engineering organization, in concurrence with the fracture control authority shall be responsible for maintaining, changing and establishing new hardware-specific fracture control requirements. The hardware developer or sustaining engineering organization shall perform a drawing review process that identifies fracture control parts, identifies all areas of the parts requiring fracture critical NDE inspection, and identifies the appropriate type of fracture critical NDE inspections during manufacturing, maintenance and operations for all areas of the parts. The review process shall include NDE engineering. NDE Engineering shall ensure that the identified areas are inspectable, and that efficient and reliable NDE methods are selected.

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NASA-STD-(I)-5009

A.1.3 Responsibility of NDE Standards, Procedures, Reference Standards During Hardware Development and Manufacturing

The hardware developer's responsible NDE engineering shall be responsible for establishing and approving NDE method standards, NDE procedures, NDE reference standards and ensuring that all NDE processes are implemented through approved written NDE procedures. The NDE procedures shall be performed by the hardware developer's NDE inspection organization or by an approved external NDE organization, provided that the NDE procedures approved by responsible NDE engineering are used by personnel certified for fracture critical NDE. NDE engineering shall be responsible for administering special NDE certification tests and approving certification of the NDE personnel.

A.1.4 Responsibility of NDE Standards, Procedures, Reference Standards for Operations and Maintenance NDE

During hardware development, the hardware developer shall be responsible for establishing, approving and providing operations and maintenance NDE requirements, method standards, NDE procedures, and NDE reference standards to the sustaining engineering organization designated by the NASA responsible center. During operations and maintenance, the sustaining engineering organization, in concurrence with the fracture control authority shall be responsible for maintaining or changing existing NDE requirements, standards and procedures as well as establishing and maintaining new hardware specific NDE requirements, standards and procedures. NDE procedures may be performed by an in-house NDE inspection organization or by an external NDE inspection organization provided that the NDE procedures approved by NDE engineering are used by the personnel certified for fracture critical NDE. Responsible NDE engineering shall be responsible for administering special NDE certification tests and approving certification of the NDE personnel.

A. 1.5 NDE Drawing Callouts

The hardware developer's responsible NDE Engineering shall review the zoned drawings the NDE inspection methods, procedures and acceptance criteria. Where there are different inspection requirements for different areas of a component, the drawing shall indicate separate inspection requirements for each zone.

A.1.6 NDE Process and Configuration Control

A written NDE procedure that complies with the relevant specification for the NDE method selected for the part is required for NDE inspection of each fracture critical part. Configuration control by revision or date shall be maintained for the personnel qualifications and certifications; and, for the NDE specifications, standards, and part

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NASA-STD-(I)-5009

specific procedures. Certifications shall remain current with revisions. NDE engineering shall approve NDE process changes. The fracture control authority shall have final approval for NDE process changes that affect the reliability of fracture critical NDE.

A.1.7 Capability Demonstration Specimens

NDE engineering shall be responsible for designing, approving and providing Special NDE capability demonstration specimens. If possible, NDE engineering shall borrow the specimens from NASA or other government departments. If appropriate demonstration specimens are not available, the hardware developer or the sustaining engineering organization shall build or procure the demonstration specimens in concurrence with the fracture control authority. Capability artifacts used in NDE procedure application shall be traceable to those used in the capability demonstration of the NDE procedure.

A.1.8 Responsibilities of NDE Inspection Organization

The NDE inspection organization shall be responsible for training, qualification and facilitating NDE certification of its inspection personnel. NDE inspection shall be responsible for maintaining and operating NDE equipment and facilities used in the NDE inspection of fracture critical hardware. NDE inspection shall be responsible for retention of certification records, NDE reports and associated paperwork through the life of the program.

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